



**SEMITRANS®3**

## IGBT4 Modules

SKM300GB12E4

### Features

- IGBT4 = 4. Generation (Trench)IGBT
- VCEsat with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I<sub>CNOM</sub>
- Soft switching 4. Generation CAL diode (CAL4)

### Typical Applications

- AC inverter drives
- UPS
- Electronic welders at fsw up to 20 kHz

### Remarks

- Case temperature limited to T<sub>c</sub> = 125°C max, recomm. Top = -40 ... +150°C, product rel. results valid for T<sub>j</sub> = 150°



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Absolute Maximum Ratings				
Symbol	Conditions	Values	Unit	
<b>IGBT</b>				
V <sub>CES</sub>		1200	V	
I <sub>C</sub>	T <sub>j</sub> = 175 °C	T <sub>c</sub> = 25 °C	422	A
		T <sub>c</sub> = 80 °C	324	A
I <sub>Cnom</sub>		300	A	
I <sub>CRM</sub>	I <sub>CRM</sub> = 3xI <sub>Cnom</sub>	900	A	
V <sub>GES</sub>		-20 ... 20	V	
t <sub>psc</sub>	V <sub>CC</sub> = 800 V	T <sub>j</sub> = 150 °C	10	µs
	V <sub>GE</sub> ≤ 15 V			
	V <sub>CES</sub> ≤ 1200 V			
T <sub>j</sub>		-40 ... 175		°C
<b>Inverse diode</b>				
I <sub>F</sub>	T <sub>j</sub> = 175 °C	T <sub>c</sub> = 25 °C	353	A
		T <sub>c</sub> = 80 °C	264	A
I <sub>Fnom</sub>		300	A	
I <sub>FRM</sub>	I <sub>FRM</sub> = 3xI <sub>Fnom</sub>	900	A	
I <sub>FSM</sub>	t <sub>p</sub> = 10 ms, sin 180°, T <sub>j</sub> = 25 °C	1548	A	
T <sub>j</sub>		-40 ... 175		°C
<b>Module</b>				
I <sub>t(RMS)</sub>		500		A
T <sub>stg</sub>		-40 ... 125		°C
V <sub>isol</sub>	AC sinus 50Hz, t = 1 min	4000		V

Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
<b>IGBT</b>					
V <sub>CE(sat)</sub>	I <sub>C</sub> = 300 A V <sub>GE</sub> = 15 V chipelevel	T <sub>j</sub> = 25 °C	1.85	2.1	V
		T <sub>j</sub> = 150 °C	2.25	2.45	V
V <sub>CE0</sub>		T <sub>j</sub> = 25 °C	0.8	0.9	V
		T <sub>j</sub> = 150 °C	0.7	0.8	V
r <sub>CE</sub>	V <sub>GE</sub> = 15 V	T <sub>j</sub> = 25 °C	3.5	4.0	mΩ
		T <sub>j</sub> = 150 °C	5.2	5.5	mΩ
V <sub>GE(th)</sub>	V <sub>GE</sub> =V <sub>CE</sub> , I <sub>C</sub> = 12 mA	5	5.8	6.5	V
I <sub>CES</sub>	V <sub>GE</sub> = 0 V V <sub>CE</sub> = 1200 V	T <sub>j</sub> = 25 °C	0.1	0.3	mA
		T <sub>j</sub> = 150 °C			mA
C <sub>ies</sub>	V <sub>CE</sub> = 25 V	f = 1 MHz	17.6		nF
C <sub>oes</sub>	V <sub>GE</sub> = 0 V	f = 1 MHz	1.16		nF
C <sub>res</sub>		f = 1 MHz	0.94		nF
Q <sub>G</sub>	V <sub>GE</sub> = - 8 V...+ 15 V		1700		nC
R <sub>Gint</sub>	T <sub>j</sub> = 25 °C		2.5		Ω
t <sub>d(on)</sub>	V <sub>CC</sub> = 600 V	T <sub>j</sub> = 150 °C	220		ns
t <sub>r</sub>	I <sub>C</sub> = 300 A V <sub>GE</sub> = ±15 V	T <sub>j</sub> = 150 °C	44		ns
E <sub>on</sub>	R <sub>G on</sub> = 1.5 Ω	T <sub>j</sub> = 150 °C	27		mJ
t <sub>d(off)</sub>	R <sub>G off</sub> = 1.5 Ω	T <sub>j</sub> = 150 °C	520		ns
t <sub>f</sub>	di/dt <sub>on</sub> = 6100 A/µs	T <sub>j</sub> = 150 °C	117		ns
E <sub>off</sub>	di/dt <sub>off</sub> = 3000 A/µs	T <sub>j</sub> = 150 °C	39		mJ
R <sub>th(j-c)</sub>	per IGBT			0.11	K/W



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Top =  $-40 \dots +150^\circ\text{C}$ , product rel. results valid for  $T_j = 150^\circ$

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
<b>Inverse diode</b>						
$V_F = V_{EC}$	$I_F = 300 \text{ A}$ $V_{GE} = 0 \text{ V}$ chip	$T_j = 25^\circ\text{C}$		2.17	2.49	V
		$T_j = 150^\circ\text{C}$		2.11	2.42	V
$V_{F0}$		$T_j = 25^\circ\text{C}$		1.3	1.5	V
		$T_j = 150^\circ\text{C}$		0.9	1.1	V
$r_F$		$T_j = 25^\circ\text{C}$		2.9	3.3	m $\Omega$
		$T_j = 150^\circ\text{C}$		4.0	4.4	m $\Omega$
$I_{RRM}$	$I_F = 300 \text{ A}$ $di/dt_{off} = 7300 \text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		345		A
$Q_{rr}$	$V_{GE} = \pm 15 \text{ V}$	$T_j = 150^\circ\text{C}$		54		$\mu\text{C}$
$E_{rr}$	$V_{CC} = 600 \text{ V}$	$T_j = 150^\circ\text{C}$		23		mJ
$R_{th(j-c)}$	per diode				0.17	K/W
<b>Module</b>						
$L_{CE}$				15	20	nH
$R_{CC'+EE'}$	terminal-chip	$T_c = 25^\circ\text{C}$		0.25		m $\Omega$
		$T_c = 125^\circ\text{C}$		0.5		m $\Omega$
$R_{th(c-s)}$	per module			0.02	0.038	K/W
$M_s$	to heat sink M6		3		5	Nm
$M_t$		to terminals M6	2.5		5	Nm
						Nm
$w$					325	g



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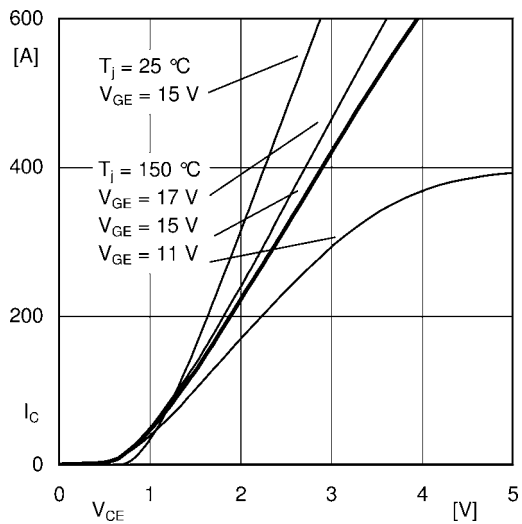


Fig. 1: Typ. output characteristic, inclusive  $R_{CC'+EE'}$

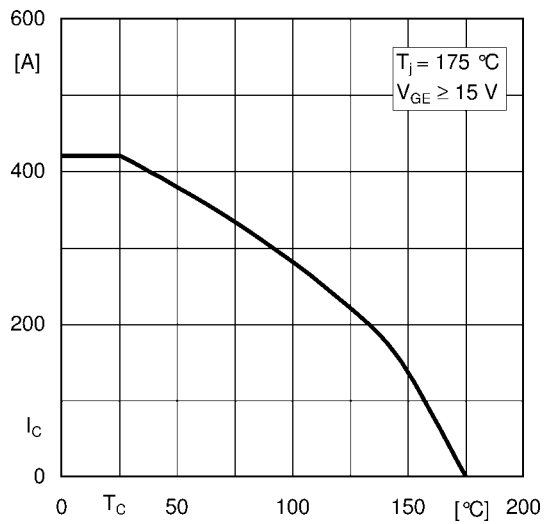


Fig. 2: Rated current vs. temperature  $I_C = f(T_C)$

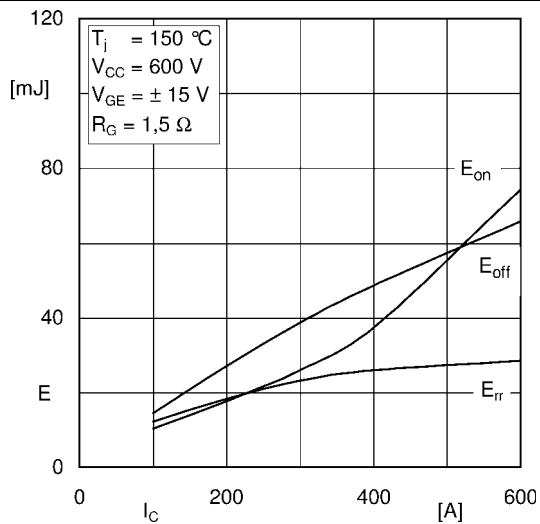


Fig. 3: Typ. turn-on /-off energy =  $f(I_C)$

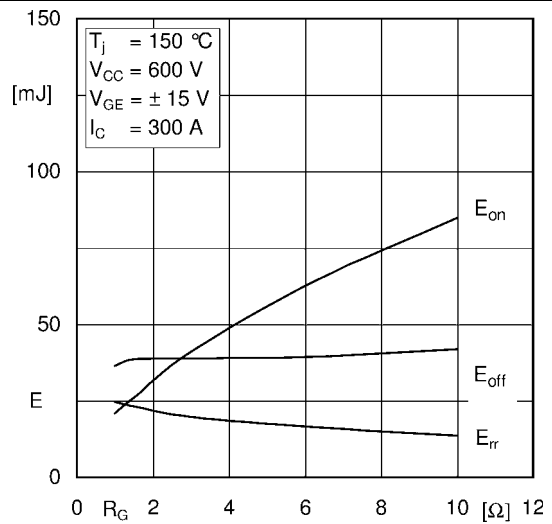


Fig. 4: Typ. turn-on /-off energy =  $f(R_G)$

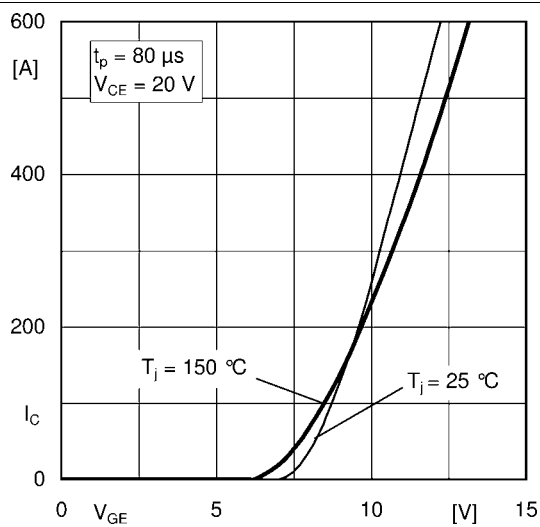


Fig. 5: Typ. transfer characteristic

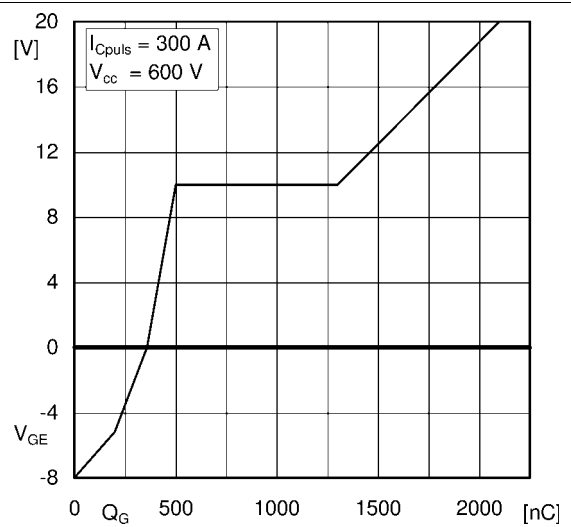


Fig. 6: Typ. gate charge characteristic

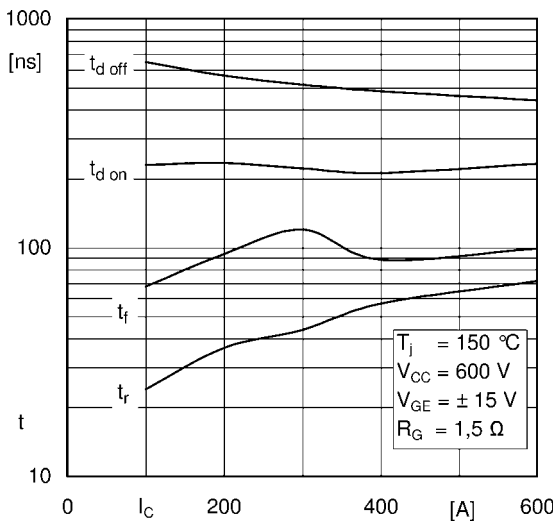


Fig. 7: Typ. switching times vs.  $I_C$

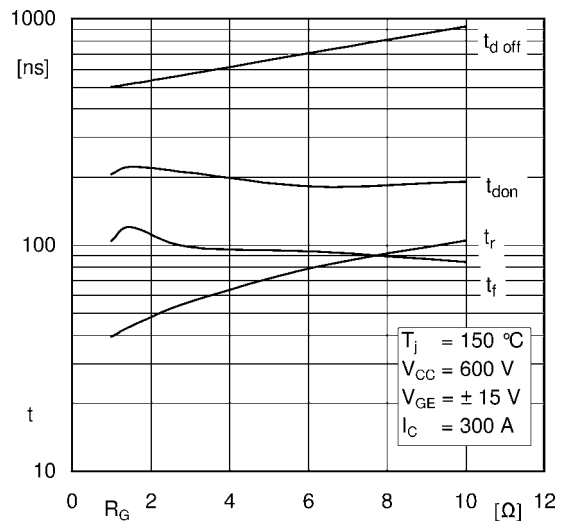


Fig. 8: Typ. switching times vs. gate resistor  $R_G$

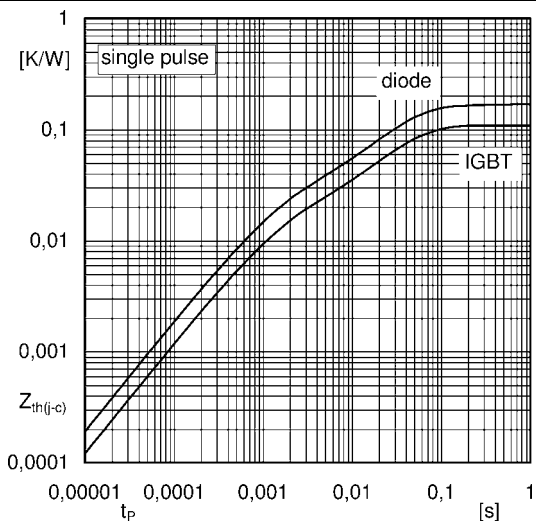


Fig. 9: Transient thermal impedance

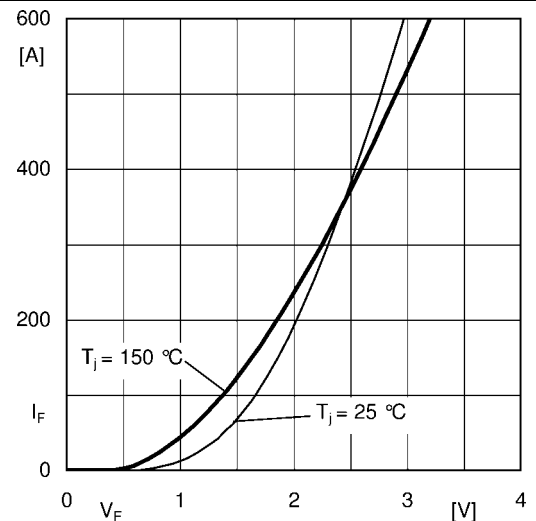


Fig. 10: CAL diode forward characteristic

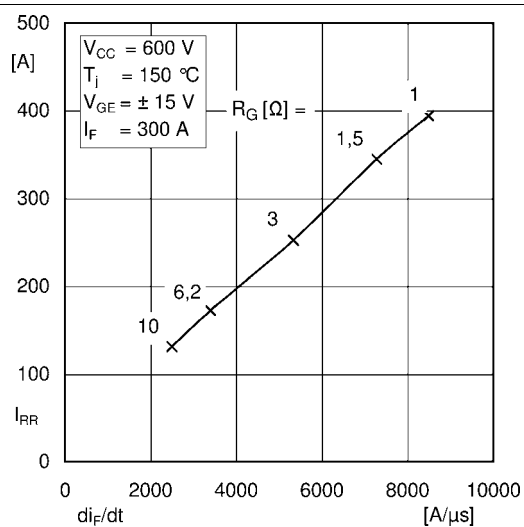


Fig. 11: CAL diode peak reverse recovery current

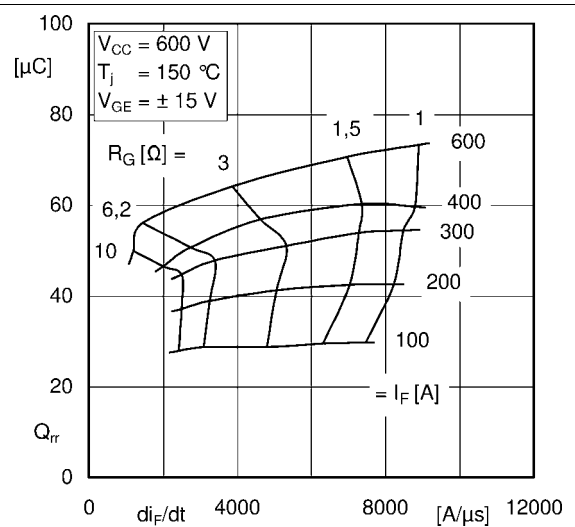
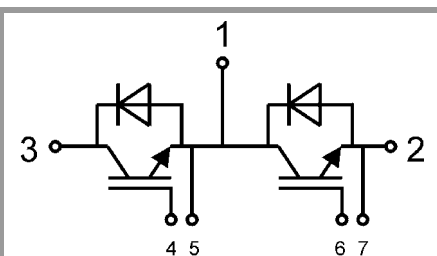


Fig. 12: Typ. CAL diode peak reverse recovery charge



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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